

## 03-09-2000





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KABUSHIKI KAISHA TOSHIBA 72, Horikawa-cho, Saiwai-ku, Kawasaki-chi, Kanagawa-ken, JAPAN  tional Name(s) and address(ss) stached?   Yes No
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PATENT REEL: 010590 FRAME: 0404



In consideration of value received, I, Yoshinori Kumura residing at 2-8-2, Shiomidai, Isogo-Ku, Yokohama-Shi, Kanagawa-Ken, Japan, an inventor of an invention described in an application for United States patent entitled: Semiconductor Device and Method for Manufacturing the Same said application having been filed on July 23, 1999 and assigned Serial No. 09/359,324; hereby sell and assign to Kabushiki Kaisha Toshiba, a corporation organized and existing under the laws of Japan, and having a business address at 72, Horikawa-cho, Saiwai-ku, Kawasaki-shi, Kanagawa-Ken, Japan, its successors, assigns or nominees, hereinafter referred to as "Assignee", my entire right, title and interest in and to said invention as disclosed, shown and described in said application for United States patent executed concurrently herewith; and in and to all applications for patent and patents for said invention, in all countries of the world, including all divisions, reissues, continuations, substitutions and extensions thereof and all rights arising under or pursuant to any and all international agreements, treaties or laws relating to the protection of industrial property, including rights of priority, resulting from the filing of any of said applications; and I authorize and request any official whose duty is to issue patents, to issue any patent on said invention or resulting therefrom to said Assignee, and I agree that on request and without further consideration, but at the expense of said Assignee, I will communicate to said Assignee or its representatives all facts known to me respecting said invention and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing, reissue, or other applications, make all rightful oaths and declarations, and generally do everything possible to aid said Assignee to obtain and enforce proper patent protection for said invention in all countries.

I hereby grant Banner & Witcoff, Ltd., 11th Floor, 1001 G Street, N.W., Washington, D.C. 20001-4597 the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the Rules of the U.S. Patent and Trademark Office for recordation of this document.

December 28, 1999

Date

Yoshinori Kumura

Hiroyales Vanaya

**RECORDED: 03/06/2000** 

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